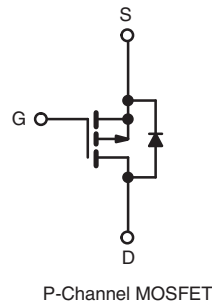
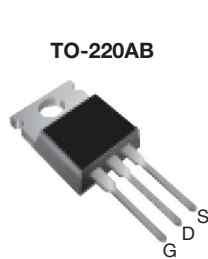


## Power MOSFET

PRODUCT SUMMARY		
$V_{DS}$ (V)	- 50	
$R_{DS(on)}$ ( $\Omega$ )	$V_{GS} = -10$ V	0.28
$Q_g$ (Max.) (nC)	26	
$Q_{gs}$ (nC)	6.2	
$Q_{gd}$ (nC)	8.6	
Configuration	Single	



### FEATURES

- P-Channel Versatility
- Compact Plastic Package
- Fast Switching
- Low Drive Current
- Ease of Paralleling
- Excellent Temperature Stability
- Compliant to RoHS Directive 2002/95/EC



Available  
**RoHS\***  
COMPLIANT

### DESCRIPTION

The Power MOSFET technology is the key to Vishay's advanced line of Power MOSFET transistors. The efficient geometry and unique processing of the Power MOSFET design achieve very low on-state resistance combined with high transconductance and extreme device ruggedness.

The P-channel Power MOSFET's are designed for application which require the convenience of reverse polarity operation. They retain all of the features of the more common N-channel Power MOSFET's such as voltage control, very fast switching, ease of paralleling, and excellent temperature stability.

P-channel Power MOSFETs are intended for use in power stages where complementary symmetry with N-channel devices offers circuit simplification. They are also very useful in drive stages because of the circuit versatility offered by the reverse polarity connection. Applications include motor control, audio amplifiers, switched mode converters, control circuits and pulse amplifiers.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF9Z20PbF SiHF9Z20-E3
SnPb	IRF9Z20 SiHF9Z20



ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ , unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		$V_{DS}$	- 50	V	
Gate-Source Voltage		$V_{GS}$	$\pm 20$		
Continuous Drain Current	$V_{GS}$ at - 10 V	$I_D$	$T_C = 25^\circ\text{C}$	- 9.7	A
			$T_C = 100^\circ\text{C}$	- 6.1	
Pulsed Drain Current <sup>a</sup>		$I_{DM}$	- 39		
Linear Derating Factor			0.32	W/ $^\circ\text{C}$	
Inductive Current, Clamped	$L = 100 \mu\text{H}$	$I_{LM}$	- 39	A	
Unclamped Inductive Current (Avalanche Current)		$I_L$	- 2.2	A	
Maximum Power Dissipation	$T_C = 25^\circ\text{C}$	$P_D$	40	W	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	- 55 to + 150	$^\circ\text{C}$	
Soldering Recommendations (Peak Temperature)	for 10 s		300 $^\circ\text{C}$		

#### Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 14).
- $V_{DD} = -25$  V, starting  $T_J = 25^\circ\text{C}$ ,  $L = 100 \mu\text{H}$ ,  $R_g = 25 \Omega$
- 0.063" (1.6 mm) from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	$R_{thJA}$	-	80	°C/W
Case-to-Sink, Flat, Greased Surface	$R_{thCS}$	1.0	-	
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	3.1	

SPECIFICATIONS ( $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0\text{ V}, I_D = -250\text{ }\mu\text{A}$	- 50	-	-	V
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\text{ }\mu\text{A}$	- 2.0	-	- 4.0	V
Gate-Source Leakage	$I_{GSS}$	$V_{GS} = \pm 20\text{ V}$	-	-	$\pm 500$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = \text{max. rating}, V_{GS} = 0\text{ V}$	-	-	- 250	$\mu\text{A}$
		$V_{DS} = \text{max. rating} \times 0.8, V_{GS} = 0\text{ V}, T_J = 125\text{ }^\circ\text{C}$	-	-	- 1000	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = -10\text{ V}, I_D = -5.6\text{ A}^b$	-	0.20	0.28	$\Omega$
Forward Transconductance	$g_{fs}$	$V_{DS} = 2 \times V_{GS}, I_{DS} = -5.6\text{ A}^b$	2.3	3.5	-	S
<b>Dynamic</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{ V}, V_{DS} = -25\text{ V}, f = 1.0\text{ MHz}, \text{ see fig. 9}$	-	480	-	$\mu\text{F}$
Output Capacitance	$C_{oss}$		-	320	-	
Reverse Transfer Capacitance	$C_{rss}$		-	58	-	
Total Gate Charge	$Q_g$	$V_{GS} = -10\text{ V}, I_D = -9.7\text{ A}, V_{DS} = -0.8\text{ max. rating}, \text{ see fig. 17}$	-	17	26	nC
Gate-Source Charge	$Q_{gs}$		-	4.1	6.2	
Gate-Drain Charge	$Q_{gd}$		-	5.7	8.6	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -25\text{ V}, I_D = -9.7\text{ A}, R_g = 18\text{ }\Omega, R_D = 2.4\text{ }\Omega, \text{ see fig. 16}$ (MOSFET switching times are essentially independent of operating temperature)	-	8.2	12	ns
Rise Time	$t_r$		-	57	86	
Turn-Off Delay Time	$t_{d(off)}$		-	12	18	
Fall Time	$t_f$		-	25	38	
Internal Drain Inductance	$L_D$	Between lead, 6 mm (0.25") from package and center of die contact 	-	4.5	-	nH
Internal Source Inductance	$L_S$		-	7.5	-	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Source-Drain Diode Current	$I_S$	MOSFET symbol showing the integral reverse p - n junction diode 	-	-	- 9.7	A
Pulsed Diode Forward Current <sup>a</sup>	$I_{SM}$		-	-	- 39	
Body Diode Voltage	$V_{SD}$	$T_J = 25\text{ }^\circ\text{C}, I_S = -9.7\text{ A}, V_{GS} = 0\text{ V}^b$	-	-	- 6.3	V
Body Diode Reverse Recovery Time	$t_{rr}$	$T_J = 25\text{ }^\circ\text{C}, I_F = -9.7\text{ A}, dI/dt = 100\text{ A}/\mu\text{s}^b$	56	110	280	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$		0.17	0.34	0.85	$\mu\text{C}$
Forward Turn-On Time	$t_{on}$	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )				

**Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 14).
- b. Pulse width  $\leq 300\text{ }\mu\text{s}$ ; duty cycle  $\leq 2\%$ .

## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

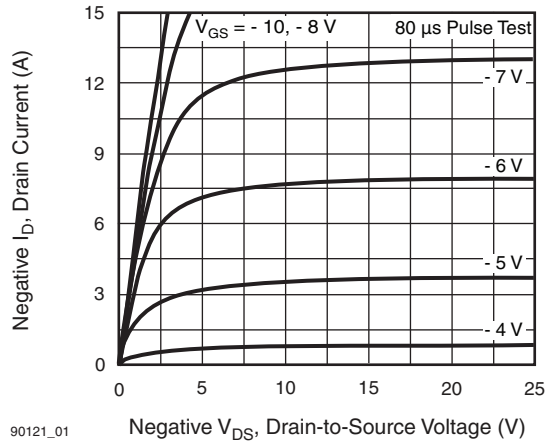


Fig. 1 - Typical Output Characteristics

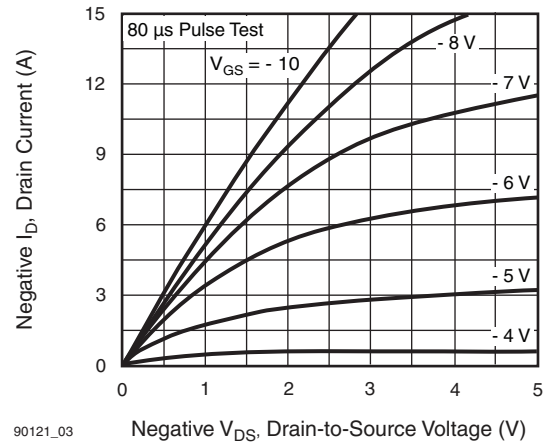


Fig. 3 - Typical Saturation Characteristics

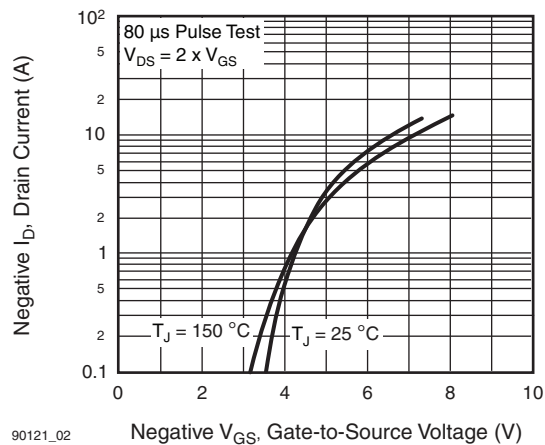


Fig. 2 - Typical Transfer Characteristics

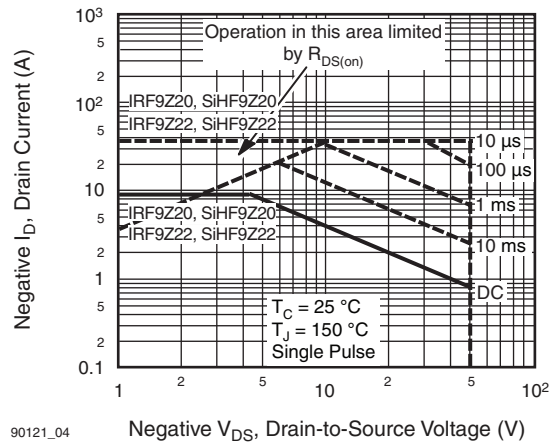
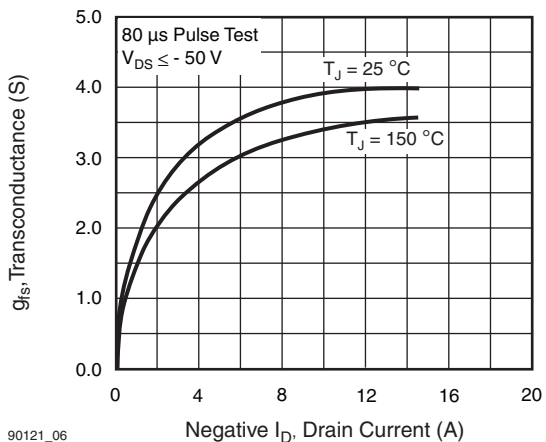
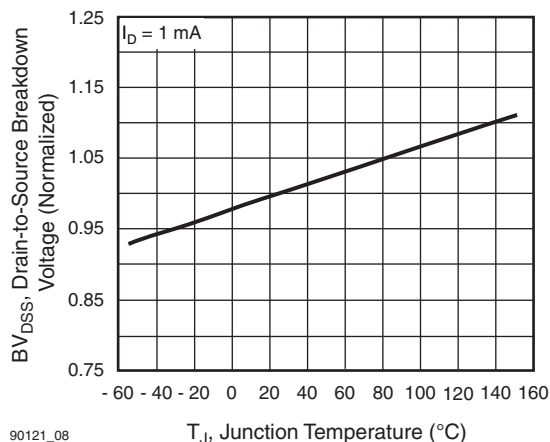


Fig. 4 - Maximum Safe Operating Area



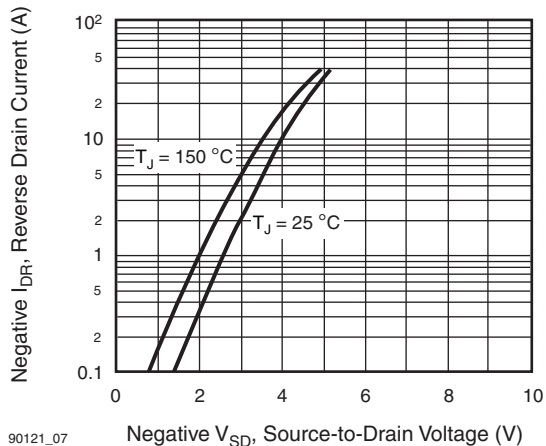
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**Fig. 5 - Typical Transconductance vs. Drain Current**



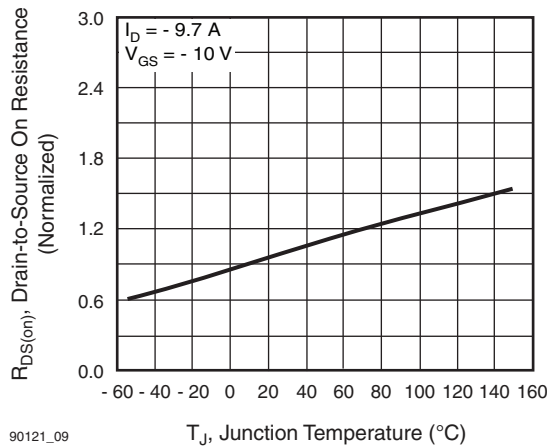
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**Fig. 7 - Breakdown Voltage vs. Temperature**



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**Fig. 6 - Typical Source-Drain Diode Forward Voltage**



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**Fig. 8 - Normalized On-Resistance vs. Temperature**

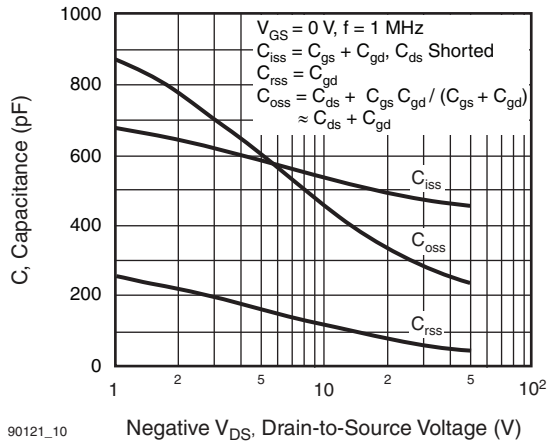


Fig. 9 - Typical Capacitance vs. Drain-to-Source Voltage

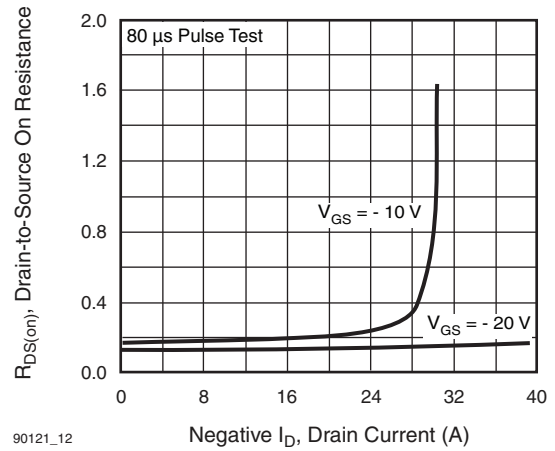


Fig. 11 - Typical On-Resistance vs. Drain Current

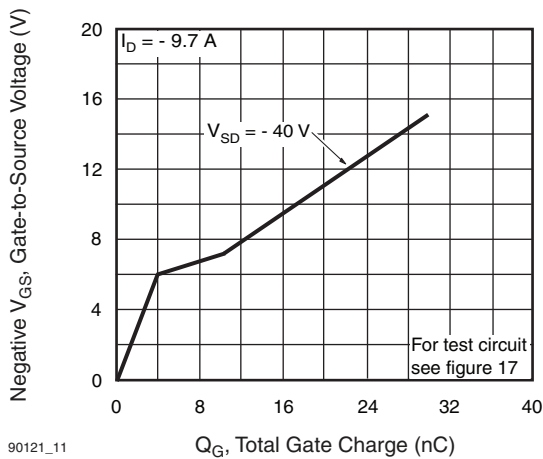


Fig. 10 - Typical Gate Charge vs. Gate-to-Source Voltage

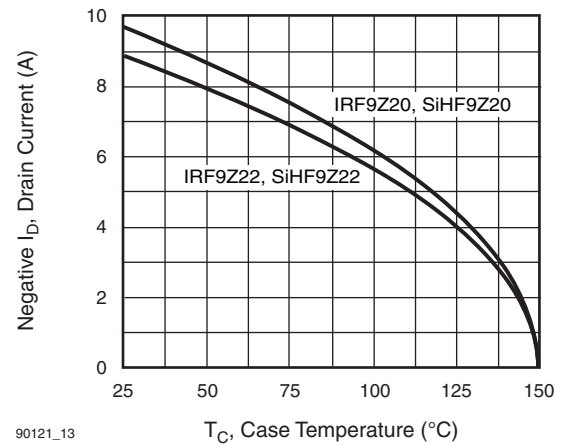


Fig. 12 - Maximum Drain Current vs. Case Temperature

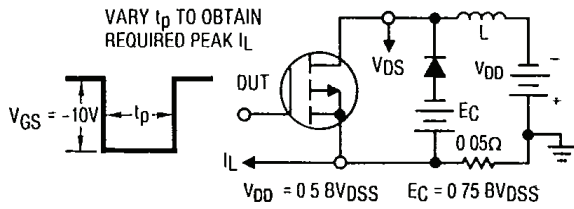


Fig. 13a - Unclamped Inductive Test Circuit

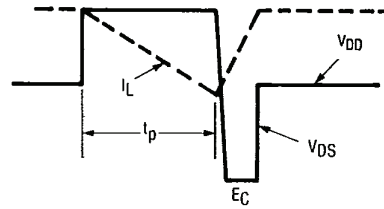
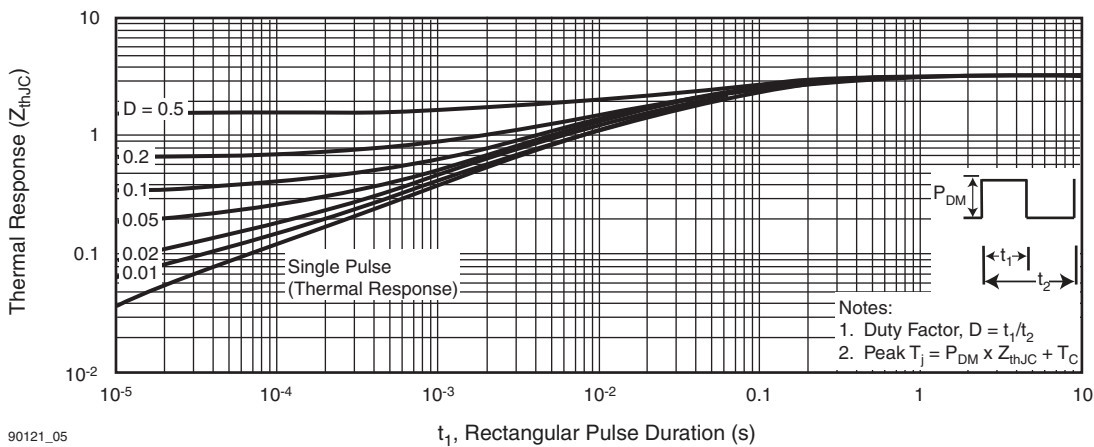


Fig. 13b - Unclamped Inductive Load Test Waveforms



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Fig. 14 - Maximum Effective Transient Thermal Impedance, Junction-to-Case vs. Pulse Duration

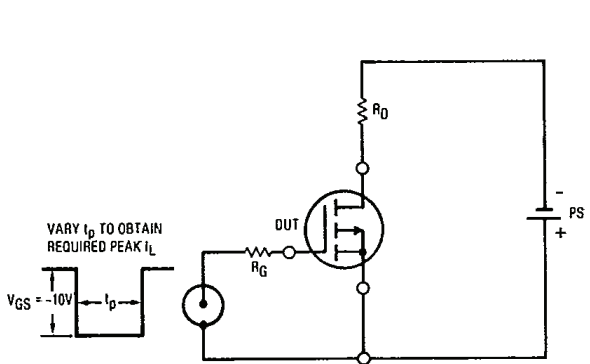


Fig. 15 - Switching Time Test Circuit

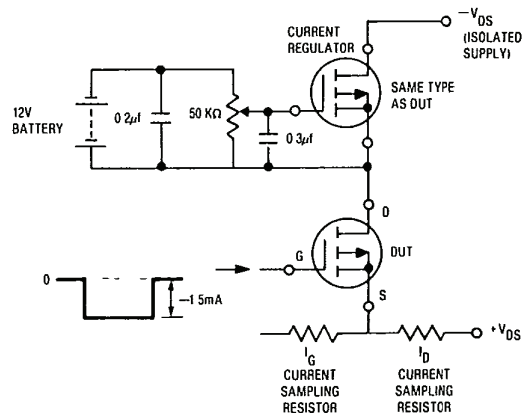
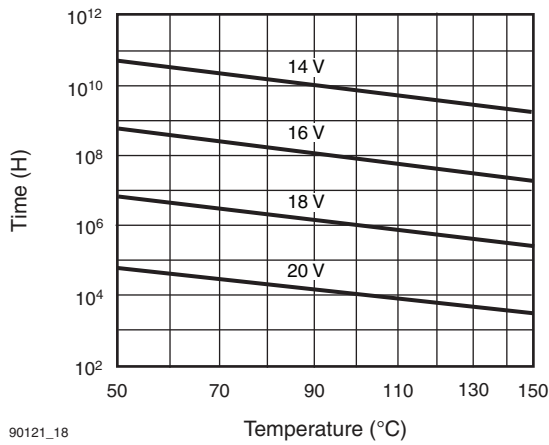
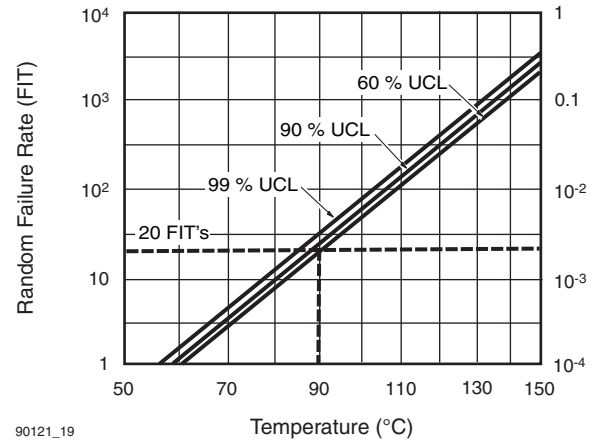


Fig. 16 - Gate Charge Test Circuit



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Fig. 17 - Typical Time to Accumulated 1 % Gate Failure



90121\_19

Fig. 18 - Typical High Temperature Reverse Bias (HTRB) Failure Rate

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**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**





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- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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**Факс:** 8 (812) 320-02-42

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**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.